## 60W, 28V High Power RF LDMOS FETs

## Description

The MR2006C is a 60-watt, unmatched LDMOS FETs, designed for Wide-band and Mobile radio applications with frequencies under 2000 MHz. It can be used in Class AB/B and Class C for all typical modulation formats.

#### It can also operate at lower voltage down to 12V with decreased power capability.

Typical Performance (On Innogration fixture with device soldered):

 $V_{DD} = 28 \text{ Volts}, I_{DQ} = 400 \text{ mA}, CW.$ 

Frequency	Gp (dB)	P <sub>-1dB</sub> (W)	η <sub>D</sub> @P <sub>-1</sub> (%)	
1000 MHz	20	60	60	

# MR2006C

#### Notice:

It is recommended to operate this device only below 24V like 14V,12V etc, if operation band is below 500MHz.

#### **Features**

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift

- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

## **Suitable Applications**

- 30-88MHz (Ground communication)
- 54-88MHz (TV VHF I)
- 88-108MHz (FM)
- 118 -140MHz (Avionics)

- 136-174MHz (Commercial ground communication)
- 160-230MHz (TV VHF III)
- 30-512MHz (Jammer, Ground/Air communication)
- 470-860MHz (TV UHF)

#### **Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	+65	Vdc
GateSource Voltage	$V_{GS}$	-10 to +10	Vdc
Operating Voltage	V <sub>DD</sub>	+32	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C
Operating Junction Temperature	TJ	+225	°C

#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Rejc	0.9	°C/W
T <sub>C</sub> = 85°C, T <sub>J</sub> =200°C, DC test	Kejc	0.9	-C/VV

#### **Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22A114)	Class 2

## Table 4. Electrical Characteristics (T<sub>A</sub> = 25 °C unless otherwise noted)

Characteristic   Symbol   Min   Typ   Max   Unit	Characteristic	Symbol	Min	Тур	Max	Unit
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#### DC Characteristics (per half section)

Drain-Source Voltage V <sub>GS</sub> =0, I <sub>DS</sub> =1.0mA	$V_{\text{(BR)DSS}}$	65	69		V
Zero Gate Voltage Drain Leakage Current (V <sub>DS</sub> = 28 V, V <sub>GS</sub> = 0 V)	I <sub>DSS</sub>			1	μА
GateSource Leakage Current (V <sub>GS</sub> = 9 V, V <sub>DS</sub> = 0 V)	I <sub>GSS</sub>			1	μА
Gate Threshold Voltage $(V_{DS} = 28V, I_D = 600 \mu A)$	$V_{\rm GS}({ m th})$		1.95		V
Common Source Input Capacitance (V <sub>GS</sub> = 0V, V <sub>DS</sub> =14 V, f = 1 MHz)	C <sub>ISS</sub>		24.8		pF
Common Source Output Capacitance (V <sub>GS</sub> = 0V, V <sub>DS</sub> =14 V, f = 1 MHz)	C <sub>oss</sub>		14.0		pF
Common Source Feedback Capacitance (V <sub>GS</sub> = 0V, V <sub>DS</sub> =14 V, f = 1 MHz)	C <sub>RSS</sub>		0.65		pF
Common Source Input Capacitance (V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	C <sub>ISS</sub>		24.6		pF
Common Source Output Capacitance (V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	C <sub>oss</sub>		10.6		pF
Common Source Feedback Capacitance (V <sub>GS</sub> = 0V, V <sub>DS</sub> =28 V, f = 1 MHz)	C <sub>RSS</sub>		0.53		pF

Functional Tests (On Demo Test Fixture, 50 ohm system)  $V_{DD}$  = 28 Vdc,  $I_{DQ}$  = 400 mA, f = 1000 MHz, CW Signal Measurements.

Power Gain	Gp	20	dB
Drain Efficiency@P1dB	$\eta_{\scriptscriptstyle D}$	60	%
1 dB Compression Point	P <sub>-1dB</sub>	60	W
Input Return Loss	IRL	-7	dB

Load Mismatch (In Innogration Test Fixture, 50 ohm system):  $V_{DD} = 28 \text{ Vdc}$ ,  $I_{DQ} = 400 \text{ mA}$ , f = 1000 MHz

VSWR 10:1 at 60W pulse CW Output Power	No Device Degradation
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# **Package Outline**

Flanged ceramic package; 2 mounting holes; 4 leads

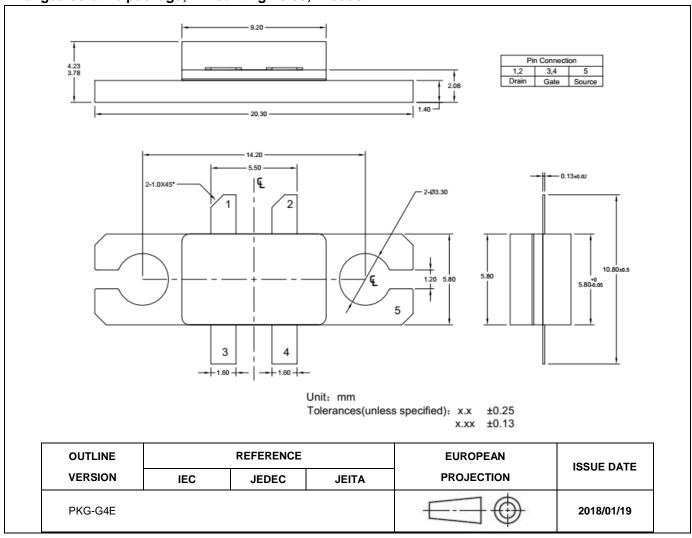


Figure 1. Package Outline PKG-G4E

# MR2006C LDMOS TRANSISTOR

Document Number: MR2006C Objective Datasheet V1.1

### **Revision history**

#### Table 5. Document revision history

Date	Revision	Datasheet Status
2018/6/14	Rev 1.0	Objective Datasheet
2018/8/2	Rev 1.1	Add notice of below 500MHz operation

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